## The dRICH Project

The dual-radiator RICH has been a common reference in the forward region since EIC Yellow Report Moving from generic EIC R&D (eRD14) to targeted EIC R&D (eRD102, eRD110, eRD...)



p: 41 GeV, 100 to 275 GeV	p/A beam	e beam	e: 5 GeV to 18 GeV	
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## dRICH Prototype

Based on experience from previous realizations (HERMES, COMPASS, CLAS12, Hall-A)



### Goals:

- Study dual radiator performance and interplay
- Study specifications and alternatives for optical components
- Test alternate single-photon detection systems
- Design parameters and optimization

Basic system commissioned in 2021 runs

## dRICH Cherenkov Rings

A tracking system based on two GEM detectors was used during the test beam to track the beam particles for measuring alignment and beam divergence.

The combination of the dRICH optical information and GEM track information allows to correct data on an event by event analysis.





 $\pi$  rings



θ x [Rad]

## dRICH Resolution



Preparing the prototype for the next test beam campaign (fall 2022)

## The SiPM Program

Based on previous R&D (CLAS12), INFN developments (DARKSIDE, ALCOR, ARCADIA) and local facilities (development at FBK, production at Lfoundry)

Control SiPM high dark count rate and radiation damage to isolate single photon signal Use a new ALCOR chip (high-rate ToT architecture) in streaming mode (50 ps time bin, > 500 kHz rate per channel, cryogenic compatible)





Study SiPM performance of various producers and types (Hamamatsu, FBK, Bradcom, On Semiconductor)

## SiPM Irradiation Campaign



## SiPM Annealing

### Study customized annealing (current shots)

### Reproduce long-term high-T annealing (oven)

![](_page_6_Picture_3.jpeg)

dRICH @ EIC User Group Meeting - 27th July 2022

## First Beam Test

### Test Cherenkov application for magnetic field insensitive sensor (SiPM)

Control SiPM high dark count to isolate single photon signal (same amplitude!) Use a new ALCOR chip (high-rate ToT architecture) in streaming mode

![](_page_7_Figure_3.jpeg)

dRICH @ EIC User Group Meeting - 27th July 2022

# ALCORv2 Chip

### ALCOR-v2 fro EIC applications

Optimised version ALCOR-EIC submitted at the end of May.

#### **New Features:**

Higher amplifier gain to optimise application with lower gain SiPM:

- one additional gain configuration (16/3) has been implemented
- the lower gain configuration (10/3) has also been maintained

The internal pulse generator has been modified to support both signal polarities

The front-end bias has been improved to reduce the noise level

Fifo controllers have been rewritten, using gray counters, to avoid spike on FIFO enable signal

A new top level of the ASIC has been generated: the old one was not anymore compatible with the design kit. Maintained same size, pins, etc

![](_page_8_Picture_11.jpeg)

## dRICH DAQ

Table 2.5: Maximum data volume by detector.

Based	on p	reliminary	studies in	synergy with	JLab
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Needs smart solutions to deal with large data volume and to migrate towards consolidated architecture

This was computed assuming an average 300 kHz DCR per pixel before moving to annealing cycles and a factor 3 reduction due to timing selection (it might be 5)

ALCOR: 64 bit per hit (TOT)

Detector	Channels	DAQ Input (Gbps)	DAQ Output (Gbps)
B0 Si	400 M	<1	<1
B0 AC-LGAD	500k	<1	<1
RP+OMD+ZDC	700k	<1	<1
FB Cal	4k	80	1
ECal	34k	5	5
HCal	39k	5.5	5.5
Imaging bECal	619M	4	4
Si Tracking	60B	5	5
Micromegas Tracking	66k	2.6	.6
GEM Tracking	28k	2.4	.5
uRWELL Tracking	50k	2.4	.5
dRICH	300k	1830	14
pfRICH	225k	1380	12
DIRC	100k	11	11
TOF	332k	3	.8
Total		3334	62.9

![](_page_9_Figure_7.jpeg)

## dRICH Simulations

Excellent team at work, but facing limited time availability and fast evolving framework Dedicated manpower would be crucial to meet project CD deadlines

dRICH performance is strictly related to the EPIC global layout

#### Principle

- low-n (gas) radiator @ high-energy o long path for light yield
- resolution vs emission point o proper light focalization

#### Consequence

- extensive volume and not trivial geometry
- bending inside the magnetic field

Goal: study realistic implementation for EPIC

compare with YR specifications

benchmark with prototype performance

![](_page_10_Figure_12.jpeg)

![](_page_10_Figure_13.jpeg)

## dRICH for EPIC

Study optics vs geometry constraints

radiator n vs thickness

focal plane vs detector surface

#### Study magnetic bending effect

....

![](_page_11_Figure_5.jpeg)

![](_page_11_Figure_6.jpeg)

![](_page_11_Figure_7.jpeg)

## Aerogel

Existing facility to study detailed radiator optical properties and alternatives

Safe handling and characterization: refractive index, surface planarity, forward scattering

Budker Institute - Russia: not accessible

Aerogel Factory - Japan: good quality, working on dimensions (in collaboration with ALICE3) ASPEN – USA: promising quality for n=1.02, awaiting validation (in collaboration with CUA)

![](_page_12_Picture_5.jpeg)

![](_page_12_Picture_6.jpeg)

![](_page_12_Figure_7.jpeg)

## Mirrors

Existing facility to study detailed mirror optical properties and alternatives

Safe handling and characterization procedures (surface map, radius of curvature, reflectivity)

CMA - USA: Carbon fiber (HERMES, AMS, LHCb, CLAS12) requires validation for EIC (2023)

Media-Lario: Glass skin (cost-effective) requires specific R&D

![](_page_13_Picture_5.jpeg)

![](_page_13_Figure_6.jpeg)

## Mechanics

Assuming composite materials from aeronautics technology

Stiff and light, with a skeleton supporting alignment elements

Need guidance to select alternatives and define specifications

High-P Ar:Alternate of greenhouse gasDedicated R&D planned to start in fall 2022

stage 1: simple cylinder of candidate material(s)
stage 2: prototype on scale

![](_page_14_Figure_6.jpeg)

![](_page_14_Picture_7.jpeg)

![](_page_14_Picture_8.jpeg)

## dRICH Status and Plans

- Proto: baseline existing
   Systematics studies after proof-of-principle to benchmark design resolution
- SiPM: local facilities (FBK for development, Lfundry for production) Well structured R&D ongoing LAPPDs as alternative
- F-E: ALCOR chip INFN started R&D awaiting eR109
- DAQ: streaming readout ?
   Investigating online data selection (correlations with other detectors, off-bunch inhibit)
- Simulations: consolidate framework, natural entry point for new collaborators
- Aerogel: R&D ongoing based on experience, characterization laboratories Aerogel Factory: R&D on size ASPEN: open new R&D with US groups ?
- Mirrors: experience, characterization laboratories World leading manufacturer based in USA (CMA) R&D planned in 2023
- Mechanics: initiating a dedicated task force, high-pressure option to be validated with BNL/JLab R&D planned to start in fall 2022

# Backups

![](_page_17_Picture_0.jpeg)

# Dual Radiator RICH @ EIC

![](_page_17_Figure_2.jpeg)

![](_page_18_Picture_0.jpeg)

# Targeted R&D eRD102

Prototipe to validate dual-radiator working principle, optimize performance and define specifications for components

![](_page_18_Figure_3.jpeg)

![](_page_18_Figure_4.jpeg)

![](_page_19_Picture_0.jpeg)

# Preliminary Performance: Gas

![](_page_19_Figure_2.jpeg)

Fitting function: 
$$y = \sqrt{p \downarrow 0} \ 12 \ /x + p \downarrow 1 \ 12$$

 $p_1$  = single particle resolution constant term

 $p_0$  = single photon resolution

1.5 mm in radius ~ 1.2 mrad in angle (1.1 expected)  $\sigma_{20}$  ~ 0.45 mrad

Gas	Data	Simulation
p <sub>0</sub> [mm]	1.5	1.1
p <sub>1</sub> [mm]	0.22	0.07
Avg photon	12.8	11.3

![](_page_20_Picture_0.jpeg)

# **Preliminary Performance: Aerogel**

![](_page_20_Figure_2.jpeg)

Fitting function: 
$$y = \sqrt{p \downarrow 0} \ 12 \ /x + p \downarrow 1 \ 12$$

 $p_1$  = single particle resolution constant term

 $p_0$  = single photon resolution

1.9 mm in radius

~ 5 mrad in angle (3 mrad expected)  $\sigma_{10}$  ~ 1.5 mrad

Aerogel	Data	Simulation
p <sub>0</sub> [mm]	1.9	0.8
p1 [mm]	0.53	0.26
Avg photon	3.5	3.5

# ALCOR Chip

Towards a 3D a-SiPM

"digital tile" Developed by INFN (CSN2) for the readout of SiPMs at 77K, in the framework of Darkside

32-pixel (4x8 array) matrix mixed signal ASIC

the chip performs amplification, signal conditioning and event digitisation, and features fully digital I/O Single-photon time tagging mode or time and charge measurement

4 LVDS TX data links, SPI configuration operation up to 320 MHz (TDC binning down to 50 ps)

64-bit (32-bit on time tagging mode) event and status data is generated on-pixel and propagated down the column end of Column collects digitised data from pixels and transmits it off-chip

Top pads							
Pix0	Pix0	Pix0	Pix0	Pix0	Pix0	Pix0	Pix0
Col0	Col1	Col2	Col3	Col4	Col5	Col6	Col7
Pix1	Pix1	Pix1	Pix1	Pix1	Pix1	Pix1	Pix1
Col0	Col1	Col2	Col3	Col4	Col5	Col6	Col7
Pix2	Pix2	Pix2	Pix2	Pix2	Pix2	Pix2	Pix2
Col0	Col1	Col2	Col3	Col4	Col5	Col6	Col7
Pix3	Pix3	Pix3	Pix3	Pix3	Pix3	Pix3	Pix3
Col0	Col1	Col2	Col3	Col4	Col5	Col6	Col7
FE biasing							
End of column							
Bottom pads							

![](_page_21_Figure_8.jpeg)

![](_page_21_Figure_9.jpeg)

## First Beam Test

### Test Cherenkov application for magnetic field insensitive sensor (SiPM)

Control SiPM high dark count to isolate single photon signal (same amplitude!) Use a new ALCOR chip (high-rate ToT architecture) in streaming mode

![](_page_22_Figure_3.jpeg)

#### Time coincidence with beam particle

### Reflected signal moves with mirror

×10<sup>3</sup>

500

400

300

200

100

×10<sup>3</sup>

350

300

250

150

50

## dRICH Resolution

![](_page_23_Figure_1.jpeg)

## Next Steps for Prototype

Prepare for the next test-beam campaign (fall 2022)

![](_page_24_Picture_2.jpeg)

Direct comparison between reference (MA-PMTs) and EIC-driven (SiPM) Tagging of the beam particle